# 2SB0950 (2SB950), 2SB0950A (2SB950A)

## Silicon PNP epitaxial planar type darlington

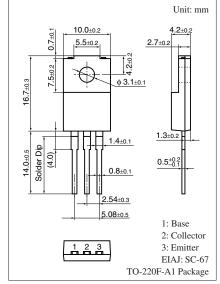
For power amplification and switching

Complementary to 2SD1276 and 2SD1276A

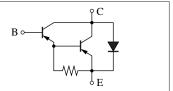
### Features

- $\bullet$  High forward current transfer ratio  $h_{FE}$
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

#### Absolute Maximum Ratings $T_C = 25^{\circ}C$ Symbol Unit Parameter Rating v 2SB0950 V<sub>CBO</sub> -60 Collector-base voltage (Emitter open) 2SB0950A -80V Collector-emitter voltage 2SB0950 V<sub>CEO</sub> -60(Base open) 2SB0950A -80Emitter-base voltage (Collector open) -5 V V<sub>EBO</sub> Collector current $I_C$ -4 А Peak collector current I<sub>CP</sub> -8А Collector power $P_C$ 40 W $T_a = 25^{\circ}C$ 2 dissipation Junction temperature Ti 150 °C Storage temperature T<sub>stg</sub> -55 to +150 °C



#### Internal Connection



#### Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SB0950	V <sub>CEO</sub>	$I_{\rm C} = -30$ mA, $I_{\rm B} = 0$	-60			V
(Base open)	2SB0950A			-80			
Base-emitter voltage		V <sub>BE</sub>	$V_{CE} = -3 V, I_C = -3 A$			-2.5	V
Collector-base cutoff	2SB0950	I <sub>CBO</sub>	$V_{CB} = -60 \text{ V}, I_E = 0$			-200	μΑ
current (Emitter open)	2SB0950A		$V_{CB} = -80 \text{ V}, I_E = 0$			-200	
Collector-emitter cutoff	2SB0950	I <sub>CEO</sub>	$V_{CE} = -30 \text{ V}, I_B = 0$			-500	μΑ
current (Base open)	2SB0950A		$V_{CE} = -40 \text{ V}, I_B = 0$			-500	
Emitter-base cutoff current (Collector open)		I <sub>EBO</sub>	$V_{EB} = -5 V, I_C = 0$			-2	mA
Forward current transfer ratio		h <sub>FE1</sub>	$V_{CE} = -3 V, I_C = -0.5 A$	1 0 0 0			
		h <sub>FE2</sub> *	$V_{CE} = -3 V, I_C = -3 A$	1 0 0 0		10 000	
Collector-emitter saturation voltage		V <sub>CE(sat)1</sub>	$I_{\rm C} = -3$ A, $I_{\rm B} = -12$ mA			-2	V
		V <sub>CE(sat)2</sub>	$I_{\rm C} = -5$ A, $I_{\rm B} = -20$ mA			-4	V
Transition frequency		f <sub>T</sub>	$V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time		t <sub>on</sub>	$I_{C} = -3 \text{ A}, I_{B1} = -12 \text{ mA}, I_{B2} = 12 \text{ mA}$		0.3		μs
Storage time		t <sub>stg</sub>	$V_{CC} = -50 \text{ V}$		2		μs
Fall time		t <sub>f</sub>			0.5		μs

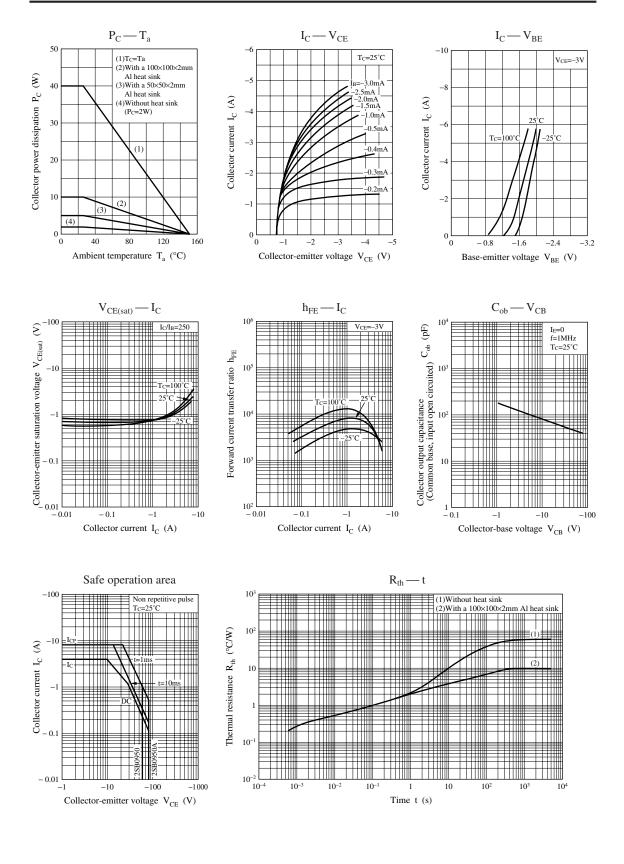
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. \*: Rank classification

Rank	R	Q	Р
h <sub>FE2</sub>	1000 to 2500	2000 to 5000	4000 to 10000

Note) The part numbers in the parenthesis show conventional part number.

### 2SB0950, 2SB0950A

# Panasonic



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